April 2009

FAIRCHILD

SEMICONDUCTOR

FGH60N60UFD 600V, 60A Field Stop IGBT

Features

- High current capability
- Low saturation voltage: V_{CE(sat)} = 1.9V @ I_C = 60A
- High input impedance
- Fast switching
- · RoHS compliant

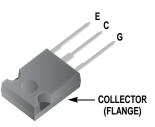
Applications

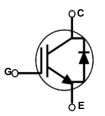
Induction Heating, UPS, SMPS, PFC



General Description

Using Novel Field Stop IGBT Technology, Fairchild's new series of Field Stop IGBTs offer the optimum performance for Induction Heating, UPS, SMPS and PFC applications where low conduc tion and switching losses are essential.





Absolute Maximum Ratings

Symbol	Description		Ratings	Units	
V _{CES}	Collector to Emitter Voltage		600	V	
V _{GES}	Gate to Emitter Voltage		± 20	V	
la	Collector Current	@ T _C = 25°C	120	A	
I _C	Collector Current	@ T _C = 100 ^o C	60	A	
I _{CM (1)}	Pulsed Collector Current	@ T _C = 25°C	180	А	
P _D	Maximum Power Dissipation	@ T _C = 25°C	298	W	
	Maximum Power Dissipation	@ T _C = 100 ^o C	119	W	
TJ	Operating Junction Temperature		-55 to +150	°C	
T _{stg}	Storage Temperature Range		-55 to +150	°C	
TL	Maximum Lead Temp. for soldering Purposes, 1/8" from case for 5 seconds		300	°C	

Notes: 1: Repetitive test , Pulse width limited by max. junction temperature

Thermal Characteristics

Symbol	Parameter	Тур.	Max.	Units
$R_{\theta JC}$ (IGBT)	Thermal Resistance, Junction to Case	-	0.33	°C/W
$R_{\theta JC}$ (Diode)	Thermal Resistance, Junction to Case	-	1.1	°C/W
R_{\thetaJA}	Thermal Resistance, Junction to Ambient	-	40	°C/W

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Device N	Device Marking Device Pa		Package	Packaging ackage Type		Qty per Tube		Max Qty per Box	
FGH60N	60UFD	FGH60N60UFDTU	TO-247			lea			
Electric	al Chai	racteristics of the	EIGBT $T_{c} = 2$	5°C unless otherwise noted	-				
Symbol		Parameter	Test	Conditions	Min.	Тур.	Max.	Units	
Off Charac	teristics								
BV _{CES}	1	to Emitter Breakdown Volta	age V _{GE} = 0V, I _C	2 = 250μA	600	-	-	V	
ΔBV_{CES}	Temperat	ure Coefficient of Breakdov			-	0.67		V/ºC	
ΔT _J	Voltage						250		
I _{CES}		Cut-Off Current	$V_{CE} = V_{CES}$		-	-	250	μΑ	
I _{GES}	G-E Leak	age Current	$V_{GE} = V_{GES}$, v _{CE} = Uv	-	-	±400	nA	
On Charac	teristics								
V _{GE(th)}	G-E Thre	shold Voltage	I _C = 250μA,	$V_{CE} = V_{GE}$	4.0	5.0	6.5	V	
			I _C = 60A, V _G	_{iE} = 15V	-	1.9	2.4	V	
V _{CE(sat)}	E(sat) Collector to Emitter Saturation Voltage		^{ge} I _C = 60A, V _G T _C = 125°C	_{;E} = 15V,	-	2.1	-	V	
Dynamic C	1				-	2855	-	~F	
C _{ies} C _{oes}	Input Cap	apacitance	V _{CE} = 30V, V	V _{CE} = 30V, V _{GE} = 0V, f = 1MHz		325	-	pF pF	
C _{res}		Transfer Capacitance				110		pr	
Ores	Reverse				_	110		рі	
Switching	Characteri	istics							
t _{d(on)}	Turn-On I	urn-On Delay Time			-	23	-	ns	
t _r	Rise Time	9			-	58	-	ns	
t _{d(off)}	Turn-Off I	Delay Time	$V_{CC} = 400V_{CC}$		-	130	-	ns	
t _f	Fall Time		$R_G = 5\Omega, V_G$		-	40	80	ns	
Eon	Turn-On S	Switching Loss		ad, T _C = 25°C	-	1.81	-	mJ	
E _{off}	Turn-Off S	Switching Loss			-	0.81	-	mJ	
E _{ts}	Total Swit	tching Loss			-	2.62	-	mJ	
t _{d(on)}	Turn-On I	Delay Time			-	22	-	ns	
t _r	Rise Time	9			-	61	-	ns	
t _{d(off)}	Turn-Off I	Delay Time	V _{CC} = 400V		-	141	-	ns	
t _f	Fall Time		$R_G = 5\Omega, V_G$		-	63	-	ns	
Eon	Turn-On S	Switching Loss	inductive Lo	ad, T _C = 125 ^o C	-	1.92	-	mJ	
E _{off}	Turn-Off S	Switching Loss			-	1.23	-	mJ	
E _{ts}	Total Swit	tching Loss			-	3.15	-	mJ	
Qg	Total Gate	e Charge			-	188	-	nC	
Q _{ge}	Gate to E	mitter Charge	$V_{CE} = 400V_{e}$, I _C = 60A,	-	21	-	nC	
Q _{gc}	Coto to C	ollector Charge	V _{GE} = 15V		-	97	-	nC	

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FGH60N60UFI
D 600V, 60A
Field Stop
IGBT

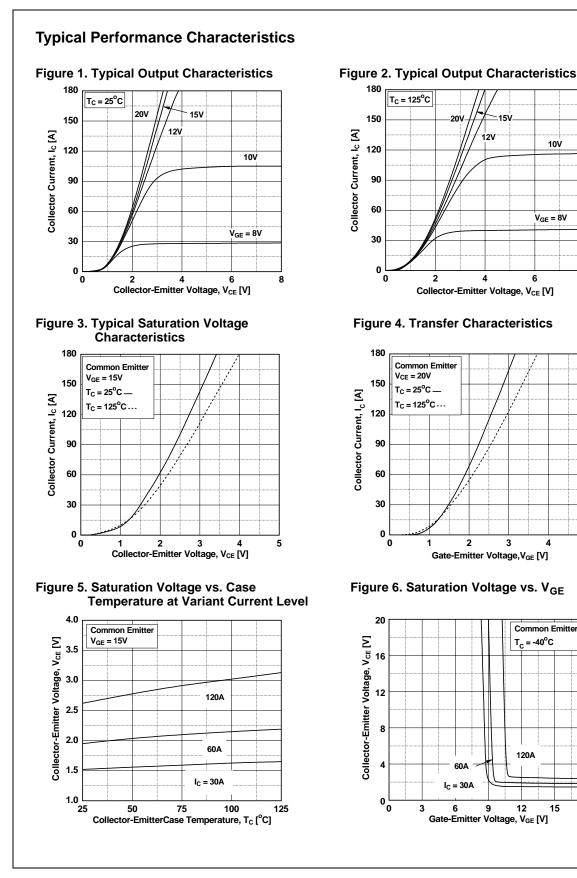
Electric	ctrical Characteristics of the Diode $T_C = 25^{\circ}C$ unless otherwise noted					
Symbol	Parameter	Test Condition	าร	Min.	Тур.	
Ven	Diode Forward Voltage	In = 30A	$T_C = 25^{\circ}C$	-	2.0	

Symbol	Parameter	Test Conditions		Min.	Тур.	Max	Units
Ven	/ _{FM} Diode Forward Voltage	$I_F = 30A$	$T_C = 25^{\circ}C$	-	2.0	2.6	V
* FIM			$T_{C} = 125^{\circ}C$	-	1.8	-	
t _{rr}	Diode Reverse Recovery Time	I _{ES} = 30A, dI _{ES} /dt = 200A/μs	$T_C = 25^{\circ}C$	-	47	-	ns
-11			$T_C = 125^{\circ}C$	-	179	-	
Q _{rr}	Diode Reverse Recovery Charge		$T_C = 25^{\circ}C$	-	83	-	nC
-11			$T_{C} = 125^{\circ}C$	-	567	-	

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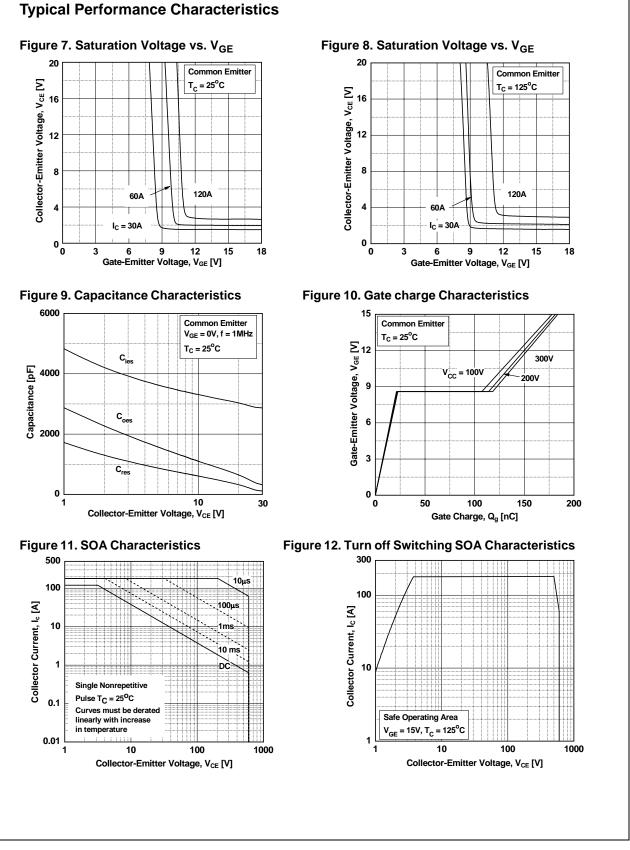
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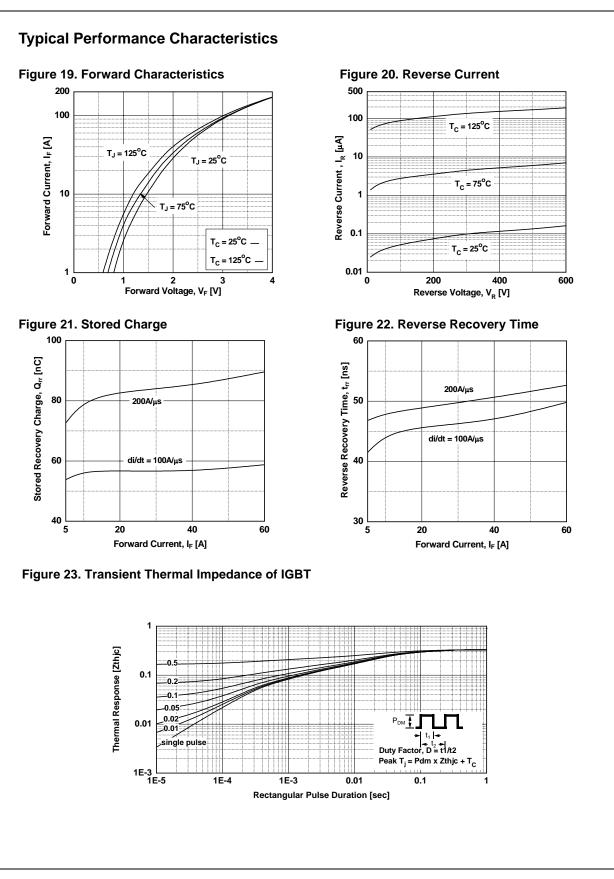
Typical Performance Characteristics Figure 13. Turn-on Characteristics vs. Figure 14. Turn-off Characteristics vs. **Gate Resistance Gate Resistance** 300 6000 Common Emitter $V_{CC} = 400V, V_{GE} = 15V$ I_C = 60A Switching Time [ns] 0001 $T_C = 25^{\circ}C$ Switching Time [ns] 00 T_C = 125^oC t, Common Emitter V_{CC} = 400V, V_{GE} = 15V I_C = 60A $T_{C} = 25^{\circ}C$ — T_C = 125°C 10 10 0 10 10 20 30 40 20 30 40 50 0 50 Gate Resistance, R_G [Ω] Gate Resistance, $R_G [\Omega]$ Figure 15. Turn-on Characteristics vs. Figure 16. Turn-off Characteristics vs. **Collector Current Collector Current** 1000 500 Common Emitter Common Emitter V_{GE} = 15V, R_G = 5Ω V_{GE} = 15V, R_G = 5Ω T_C = 25°C ____ T_c = 25°C ____ T_C = 125°C ---T_C = 125^oC Switching Time [ns] 00 Switching Time [ns] 100 off) d(oi t, 10 30 60 80 100 120 100 120 40 40 60 80 0 20 0 20 Collector Current, I_C [A] Collector Current, I_C [A] Figure 17. Switching Loss vs. Gate Resistance Figure 18. Switching Loss vs. Collector Current 20 20 Common Emitter Common Emitter $V_{GE} = 15V, R_G = 5\Omega$ $V_{CC} = 400V, V_{GE} = 15V$ 10 I_C = 60A 10 $T_{c} = 25^{\circ}C$ — T_C = 25°C ____ T_C = 125°C Switching Loss [mJ] Switching Loss [mJ] T_C = 125°C E_o, 1 1 0.1 0 20 40 60 80 100 0 10 20 30 40 50 120

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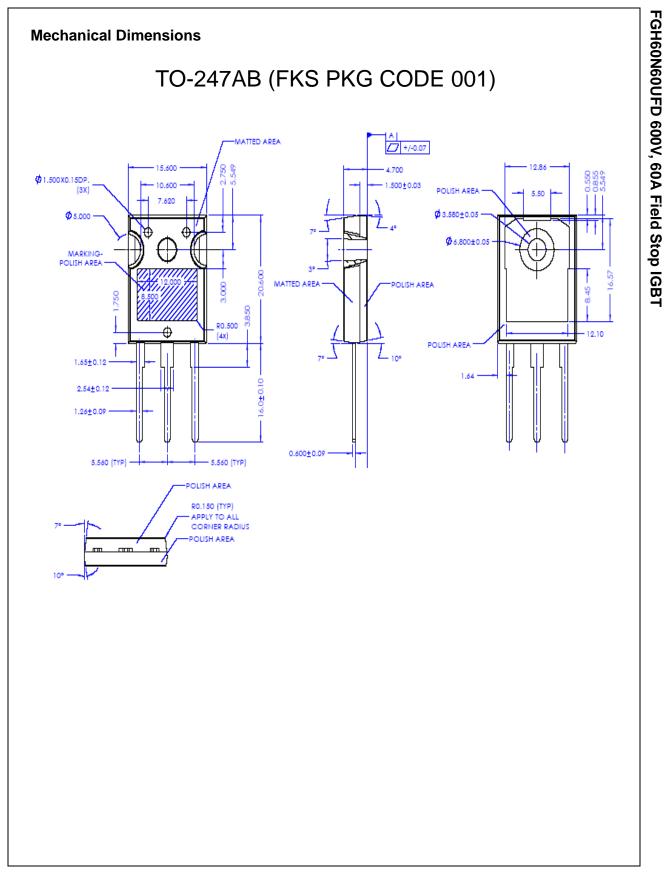
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Gate Resistance, $R_G [\Omega]$

Collector Current, I_C [A]



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